

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L7	2703	(CMP or polish\$6 or ground or grind\$6) near20 (deactivat\$6 or (de adj activat\$6) or oxidiz\$6 or oxidant or ozone or O3 or "O.sub.3") near20 (wafer or semiconductor or substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/13 16:12
L8	2326	7 and (@ad<"20030529" or @rlad<"20030529")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/13 16:12
L9	333	8 and ((dic\$6 or crib\$6 or cut\$6 or separat\$6 or saw\$6 or adhe\$6) near20 (sheet or pad or tape or carrier or adhe\$6) near20 (wafer or semiconductor or substrate))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/13 16:14